

IEEE Finland Section Report October 2013**Pasi Kallio****Highlights from the past**

- Dissemination of Recently Started EU/TEKES Projects – Novelty Aspects, Experiences and Opportunities” seminar organized by IEEE FS SP/CAS Chapter in collaboration with IEEE SB@TUT & IEEE GOLD
- Optical Measurement and Imaging seminar organized by IEEE GOLD Finland, May 29th 2013 in Oulu
- Scandinavian Conference on Image Analysis (SCIA), June 17-20 2013 in Espoo
- 11th International Conference on High Performance Computing and Simulation, July 1-5 2013 in Helsinki

Future activities

1. 13th International Conference on ITS Telecommunications and Workshops, October 16-18 2013 in Tampere
2. International Symposium on System-on-Chip (SoC), October 23-24 2013 in Tampere System-on-Chip tutorial “Many-Core Chips: The New High-Performance Computing Platform” October 22 2013 in Tampere

Best practices

- Activating industry contacts by company visits organized by chapters.
- Events (summer schools, public seminars) for students, researchers and general public.
- In Finland Section, the GOLD Affinity Group and student branch in Tampere have been particularly active.
- Participation in FINEL consisting of domestic Engineering Societies will be continued.
- The participating Societies include Finnish Automation Society, Society of Electronics Engineers, and Society of Electrical Engineers.
- FINEL provides an excellent avenue for industrial relations.

Points of concern / Topics for future discussion

- Some of the current Chapters have not been active and have not reported meetings in 2011 and 2012. They are in a high risk of dissolution.
- The establishment and registration of IEEE Finland as a branch of U.S. based legal entity.

Miscellaneous

- Region 8 Outstanding GOLD Affinity Group Award to the GOLD Affinity Group in Finland